

19th ANNUAL FIB SEM MEETING

March 23 – 24, 2027

Huang Engineering Center
Stanford University
475 Via Ortega
Stanford, CA

The FIB SEM 2027 Meeting will be held at the Huang Engineering Center at Stanford University. This will be FIB SEM's first west coast meeting!!! As usual, we will have two full days of presentations and tutorials by FIB users and vendors, highlighting interesting new applications and the latest technology. And, as always, there will be plenty of time to meet or reconnect with fellow FIBers.

We are accepting abstracts on:

- 2D & 3D FIB SEM analysis for materials and biological FIB applications
- FIB methods for semiconductor device characterization and failure analysis
- Novel FIB instrumentation and analytical capabilities
- Cryo-FIB SEM for biological and materials applications
- Correlative analysis & workflows
- Novel specimen preparation approaches
- AI & ML for FIB
- Other FIB related topics

Abstract Submission Deadline February 12, 2027

Download the abstract template [here](#).

Abstracts should be 250 words or less in length. Please email your abstracts to fibsem2027@fibsem.net

There is no fee to attend the meeting, and breakfast and lunch will be provided! And, as always, there will be a Happy Hour event Tuesday evening.

We are continuing with our student award program for best oral and poster presentation! Win up to \$500 to cover travel for the meeting (eligible expenses include hotel, food, airfare, rental vehicle/mileage). If interested, please indicate when submitting the abstract.

Visit <https://fibsem.net> for more information.

FIB SEM Organizers

Nabil Bassim, Ken Livi, Keana Scott & Samantha Stambula

Local Organizers

Colin Ophus (Stanford), Juliet Jamtgaard (Stanford)



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